

## **MR27V1652D**

1,048,576-Word x 16-Bit or 2,097,152-Word x 8-Bit

8-Word x 16-Bit or 16-Word x 8-Bit Page Mode

Production Programmed Read Only Memory (P2ROM)

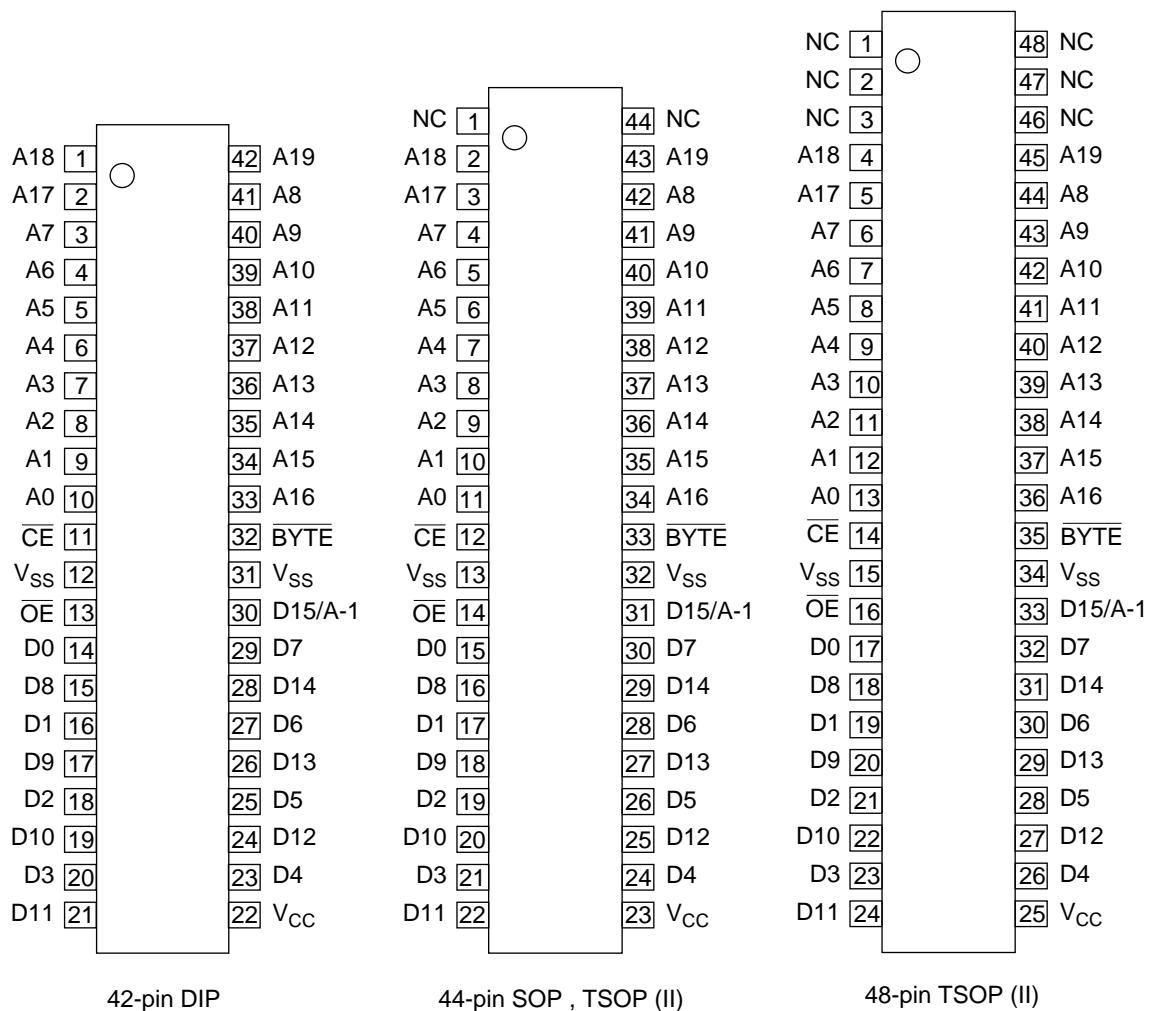
### **DESCRIPTION**

The MR27V1652D is a 16Mbit Production Programmed Read-Only Memory (P2ROM) with page mode. Its configuration can be electrically switched between 1,048,576 word x 16bit and 2,097,152 word x 8bit. The MR27V1652D operates on a single +3.3V power supply and is TTL compatible. The MR27V1652D provides Page mode which can greatly reduce the read access time. Since the MR27V1652D operates asynchronously , external clocks are not required , making this device easy-to-use. The MR27V1652D is suitable as large-capacity fixed memory for microcomputers and data terminals. It is manufactured using a CMOS double silicon gate technology and is offered in 42-pin DIP , 44-pin SOP , 44-pin TSOP or 48-pin TSOP packages.

### **FEATURES**

- 1,048,576 word x 16bit / 2,097,152 word x 8bit electrically switchable configuration
- Single +3.3V power supply
- Access time 80ns  
    Page mode access time 30ns
- Input / Output TTL compatible
- Three-state output
- Packages
  - 42-pin plastic DIP (DIP42-P-600-2.54) (Product name : MR27V1652D-xxRA)
  - 44-pin plastic SOP (SOP44-P-600-1.27-K) (Product name : MR27V1652D-xxMA)
  - 44-pin plastic TSOP (TSOP II 44-P-400-0.80-K) (Product name : MR27V1652D-xxTP)
  - 48-pin plastic TSOP (TSOP II 48-P-550-0.80-K) (Product name : MR27V1652D-xxTA)

## PIN CONFIGURATION (TOP VIEW)

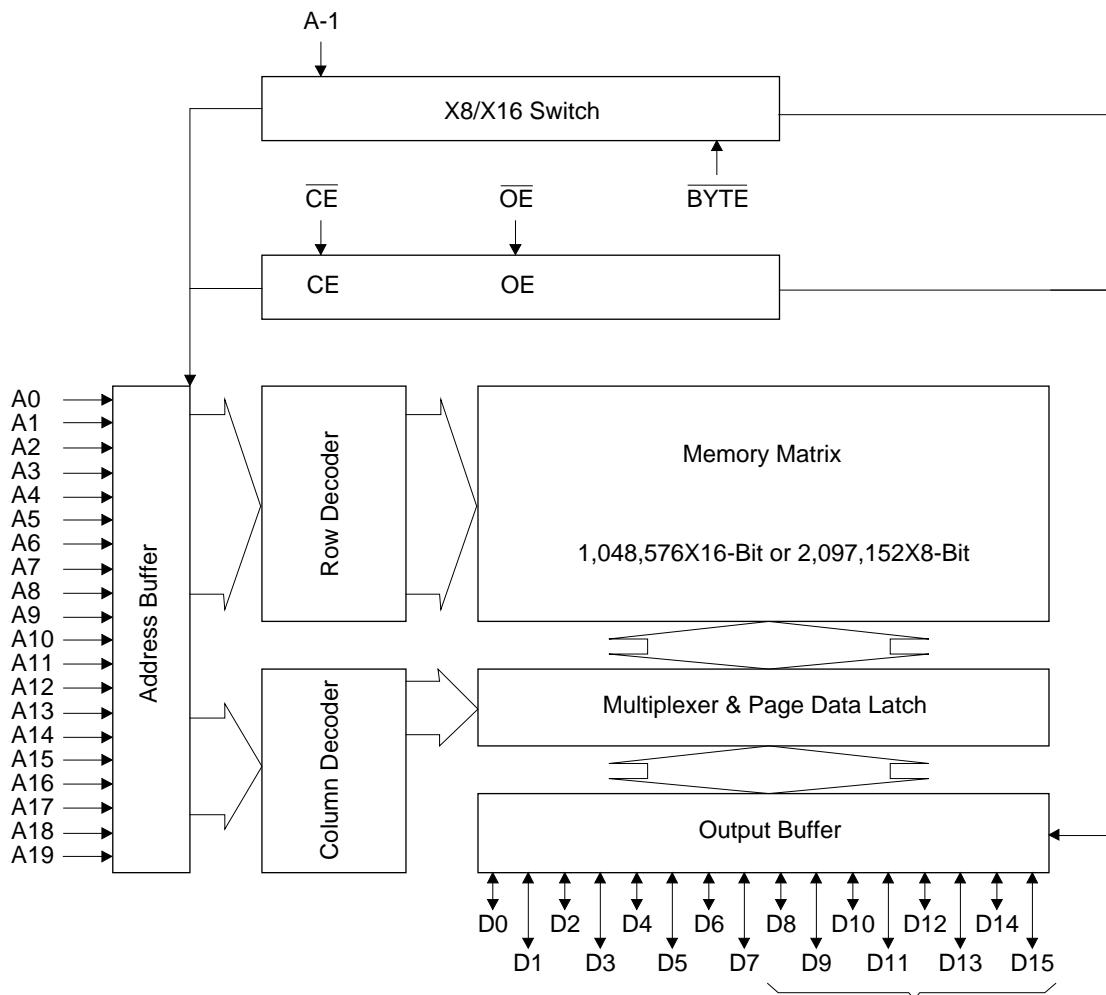


42-pin DIP

44-pin SOP , TSOP (II)

48-pin TSOP (II)

PIN NAMES	FUNCTIONS
D15/A-1	Data output / Address input
A0 - A19	Address input
D0 - D14	Data output
CE	Chip enable
OE	Output enable
V <sub>CC</sub>	Power supply voltage
V <sub>SS</sub>	GND
BYTE	Mode switch
NC	Non connection

**BLOCK DIAGRAM**

In 8-bit output mode, these pins are three-stated and pin D15 functions as the A-1 address pin.

**FUNCTION TABLE**

MODE	CE	OE	BYTE	V <sub>CC</sub>	D0 - D7	D8 - D14	D15/A-1
READ (16-Bit)	L	L	H	3.3V	D <sub>OUT</sub>		
READ (8-Bit)	L	L	L		D <sub>OUT</sub>	Hi-Z	L/H
OUTPUT DISABLE	L	H	H	3.3V	Hi-Z		*
			L		Hi-Z		*
STAND-BY	H	*	H		Hi-Z		*
			L		Hi-Z		*

\* : Don't Care

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	$T_{opr}$	-	0 to 70	°C
Storage temperature	$T_{stg}$	-	-55 to 125	°C
Input voltage	$V_I$	relative to $V_{SS}$	-0.5 to $V_{CC} + 0.5$	V
Output voltage	$V_O$		-0.5 to $V_{CC} + 0.5$	V
Power supply voltage	$V_{CC}$		-0.5 to 5	V
Power dissipation per package	$P_D$		1.0	W

**RECOMMENDED OPERATING CONDITIONS FOR READ**

(Ta=0 to 70°C)						
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
$V_{CC}$ power supply voltage	$V_{CC}$	$V_{CC}=3.0V-3.6V$	3.0	-	3.6	V
Input "H" level	$V_{IH}$		2.2	-	$V_{CC}+0.5^*$	V
Input "L" level	$V_{IL}$		-0.5**	-	0.6	V

Voltage is relative to  $V_{SS}$ \* :  $V_{CC}+1.5V$  (Max.) when pulse width of overshoot is less than 10nS.

\*\* : -1.5V (Min.) when pulse width of undershoot is less than 10nS.

**ELECTRICAL CHARACTERISTICS (Read operation)****DC Characteristics**(V<sub>CC</sub>=3.3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I <sub>LI</sub>	V <sub>I</sub> =0 to V <sub>CC</sub>	-	-	10	µA
Output leakage current	I <sub>LO</sub>	V <sub>O</sub> =0 to V <sub>CC</sub>	-	-	10	µA
V <sub>CC</sub> power supply current (Standby)	I <sub>CS1</sub>	CĒ=V <sub>CC</sub>	-	-	50	µA
	I <sub>CS2</sub>	CĒ=V <sub>IH</sub>	-	-	1	mA
V <sub>CC</sub> power supply current (Read)	I <sub>CCA</sub>	CĒ=V <sub>IL</sub> , OĒ=V <sub>IH</sub> tc=80ns	-	-	100	mA
Input "H" level	V <sub>IH</sub>	-	2.2	-	V <sub>CC</sub> +0.5*	V
Input "L" level	V <sub>IL</sub>	-	-0.5**	-	0.6	V
Output "H" level	V <sub>OH</sub>	I <sub>OH</sub> =-400µA	2.4	-	-	V
Output "L" level	V <sub>OL</sub>	I <sub>OL</sub> =2.1mA	-	-	0.4	V

Voltage is relative to V<sub>SS</sub>\*: V<sub>CC</sub>+1.5V (Max.) when pulse width of overshoot is less than 10nS.

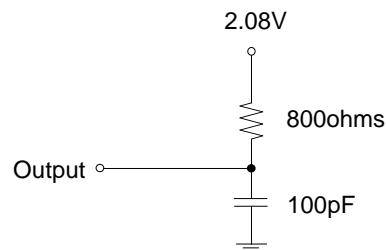
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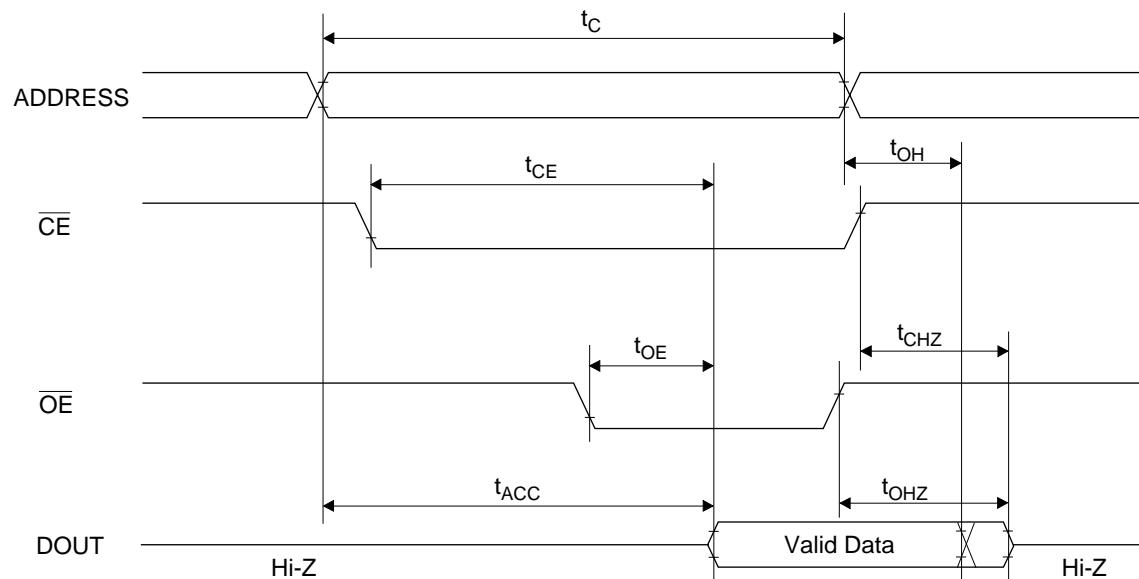
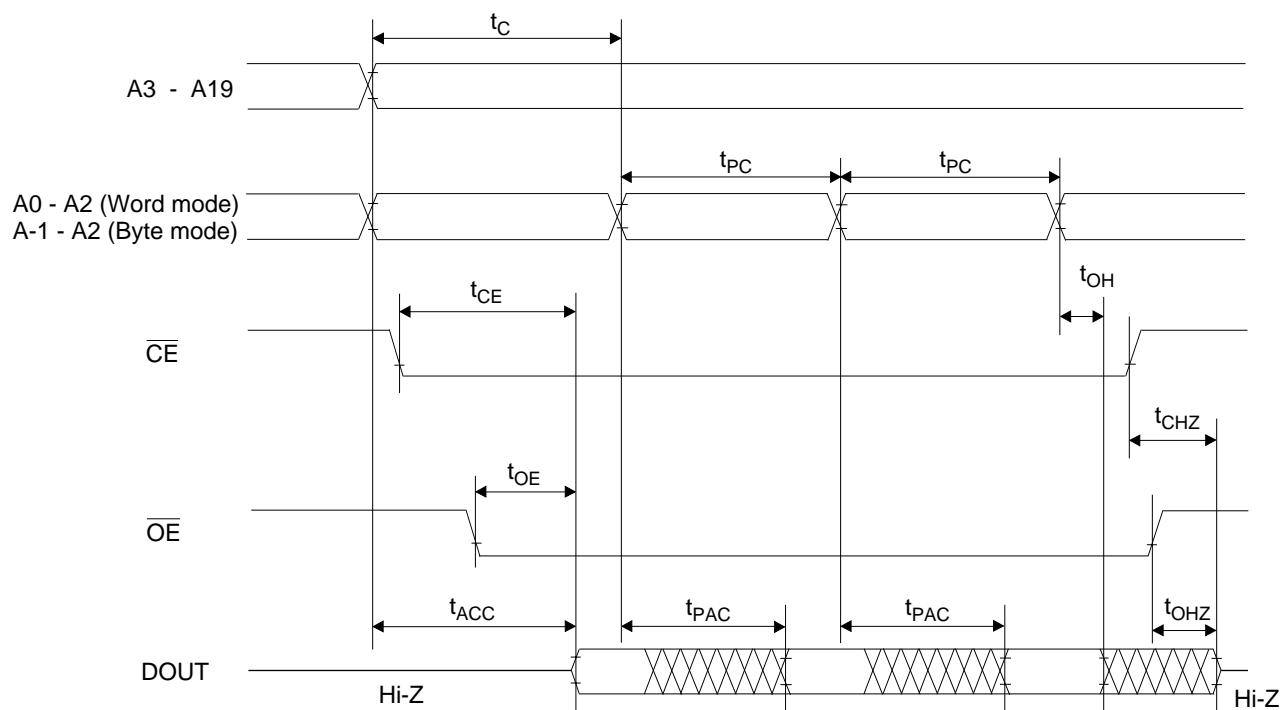
**AC Characteristics**(V<sub>CC</sub>=3.3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address access cycle time	T <sub>C</sub>	-	80	-	ns
Address access time	T <sub>ACC</sub>	CĒ=OĒ=V <sub>IL</sub>	-	80	ns
Page access cycle time	T <sub>PC</sub>	-	30	-	ns
Page access time	T <sub>PAC</sub>	-	-	30	ns
CĒ access time	T <sub>CE</sub>	OĒ=V <sub>IL</sub>	-	80	ns
OĒ access time	T <sub>OE</sub>	CĒ=V <sub>IL</sub>	-	40	ns
Output disable time	T <sub>CHZ</sub>	OĒ=V <sub>IL</sub>	0	30	ns
	T <sub>OHZ</sub>	CĒ=V <sub>IL</sub>	0	25	ns
Output hold time	T <sub>OH</sub>	CĒ=OĒ=V <sub>IL</sub>	0	-	ns

## Measurement conditions

- Input signal level ----- 0V/3V
- Input timing reference level ----- 0.8V/2.0V
- Output load ----- 100pF
- Output timing reference level ----- 0.8V/2.0V



**TIMING CHART****NORMAL MODE READ CYCLE****PAGE MODE READ CYCLE**

**PIN Capacitance** $(V_{CC}=3.3V, Ta=25^{\circ}C, f=1MHz)$ 

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	$C_{IN1}$	$V_I=0V$	-	-	8 (10)	pF
$\overline{BYTE}$	$C_{IN2}$		-	-	120	
Output	$C_{OUT}$	$V_O=0V$	-	-	10 (12)	

( ) : DIP only